

# ASMT-YTBO-0xxxx

## PLCC-6 Surface Mount Tricolor LED



### Data Sheet



Lead (Pb) Free  
RoHS 6 fully  
compliant



#### Description

This family of Surface Mount Tricolor LEDs are housed in a PLCC-6 package. They are designed with a separate heat path for each LED die, enabling them to be driven at higher current. The high reliability package is able to withstand a wide range of environmental conditions making them ideally suited for interior and exterior full color sign applications.

A super wide viewing angle of 115° combined with a built in reflector increase the intensity of the light output making these LEDs suitable for interior electronics signs applications. The black surface top provides better contrast enhancement especially in the full color sign applications.

These LEDs are compatible with reflow soldering process and to facilitate easy pick & place assembly, the LEDs are packed in EIA-compliant tape and reel. Each reel will be shipped in single intensity and color bin; except red color to provide close uniformity.

#### Features

- Industry Standard PLCC-6 package (Plastic Leaded Chip Carrier) with individual addressable pin-out for higher flexibility of driving configuration
- High reliability LED package with silicone encapsulation
- High brightness using AlInGaP and InGaN dice technologies
- Wide viewing angle at 115°
- Compatible with reflow soldering process
- JEDEC MSL 2a
- Water-Resistant (IPX6\*) per IEC 60529:2001

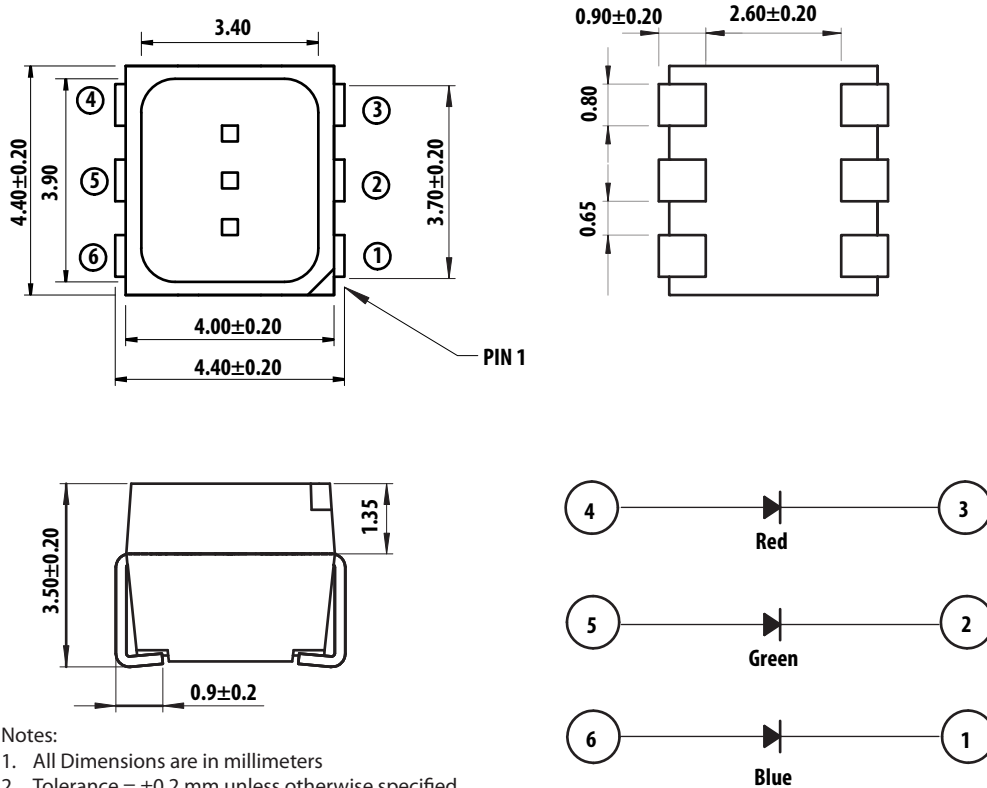
\* The test is conducted on component level by mounting the components on PCB with proper potting to protect the leads. It is strongly recommended that customers perform necessary tests on the components for their final application.

#### Applications

- Indoor and outdoor full color display

**CAUTION:** LEDs are Class 1C ESD sensitive. Please observe appropriate precautions during handling and processing. Please refer to Avago Application Note AN-1142 for additional details.

## Package Dimensions



Lead Configuration		
1	Cathode	Blue
2	Cathode	Green
3	Cathode	Red
4	Anode	Red
5	Anode	Green
6	Anode	Blue

Figure 1. Package drawing.

Table 1. Device Selection Guide

Part Number	Color 1	Color 2	Color 3
ASMT-YTB0-0xxxx	AllInGaP Red	InGaN Green	InGaN Blue

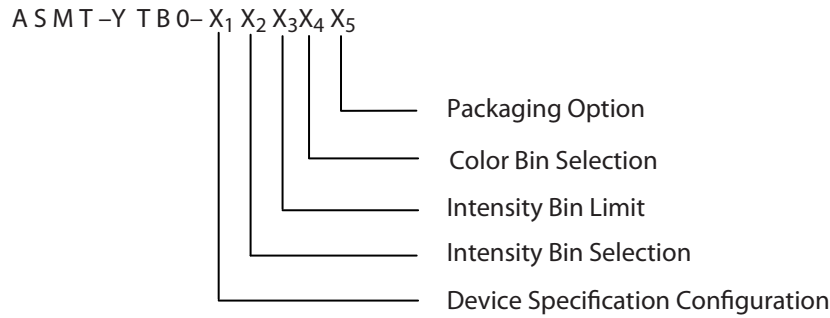
  

Part Number	Color 1 - Red			Color 2 - Green			Color 3 - Blue		
	Min. Iv @20mA	Typ. Iv @20mA		Min. Iv @20mA	Typ. Iv @20mA		Min. Iv @20mA	Typ. Iv @20mA	
ASMT-YTB0-0AA02	U1	450	648	V2	900	1243	S2	224	238

Notes:

1. The luminous intensity IV, is measured at the mechanical axis of the LED package. The actual peak of the spatial radiation pattern may not be aligned with this axis.
2. Tolerance =  $\pm 12$  %

## Part Numbering System



**Table 2. Absolute Maximum Ratings (T<sub>A</sub> = 25°C)**

Parameter	Red	Green & Blue	Unit
DC forward current <sup>[1]</sup>	50	30	mA
Peak forward current <sup>[2]</sup>	100	100	mA
Power dissipation	120	117	mW
Reverse voltage	4V <sup>[3]</sup>		V
Maximum junction temperature T <sub>j</sub> max	125		°C
Operating temperature range	- 40 to + 110 <sup>[4]</sup>		°C
Storage temperature range	- 40 to + 110		°C

Note:

1. Derate linearly as shown in Figure 5a & 5b.
2. Duty Factor = 0.5%, Frequency = 500Hz
3. Driving the LED in reverse bias condition is suitable for short term only
4. Refer to Figure 5a and figure 5b for more information

**Table 3. Optical Characteristics (T<sub>A</sub> = 25°C)**

Color	Dominant Wavelength, λ <sub>d</sub> (nm) <sup>[5]</sup>			Peak Wavelength, λ <sub>p</sub> (nm)	Viewing Angle 2θ <sub>1/2</sub> <sup>[6]</sup> (Degrees)	Luminous Efficac η <sub>v</sub> <sup>[7]</sup> (lm/W)	Luminous Efficiency η <sub>e</sub> (lm/W)	Total Flux / Luminous Intensity <sup>[8]</sup> Φ <sub>v</sub> / I <sub>v</sub> (lm/cd)
	Min	Typ.	Max	Typ.	Typ.	Typ.	Typ.	Typ.
Red	618	621	628	629	115	200	40	2.60
Green	525	528	535	521	115	530	50	2.60
Blue	465	470	475	465	115	70	10	2.60

Notes:

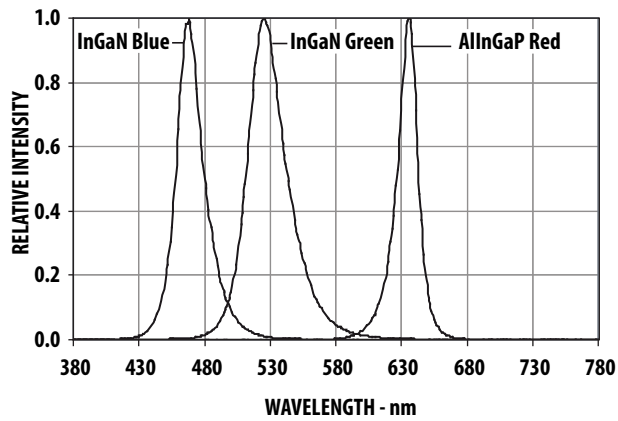
5. The dominant wavelength is derived from the CIE Chromaticity Diagram and represents the perceived color of the device.
6. θ<sub>1/2</sub> is the off axis angle where the luminous intensity is 1/2 the peak intensity
7. Radiant intensity, I<sub>e</sub> in watts / steradian, may be calculated from the equation I<sub>e</sub> = I<sub>v</sub> / η<sub>v</sub>, where I<sub>v</sub> is the luminous intensity in candelas and η<sub>v</sub> is the luminous efficacy in lumens / watt.
8. Φ<sub>v</sub> is the total luminous flux output as measured with an integrating sphere at mono pulse condition.

**Table 4. Electrical Characteristics ( $T_A = 25^\circ\text{C}$ )**

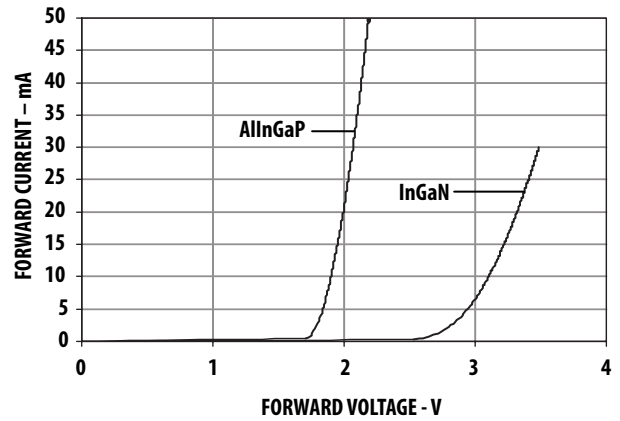
Color	Forward Voltage, $V_F$ (V) [1]			Reverse Voltage $V_R$ @ 100 $\mu\text{A}$	Reverse Voltage $V_R$ @ 10 $\mu\text{A}$
	Min	Typ.	Max.	Min.	Min.
Red	1.80	2.10	2.40	4	-
Green	2.80	3.20	3.90	-	4
Blue	2.80	3.20	3.90	-	4

Note:

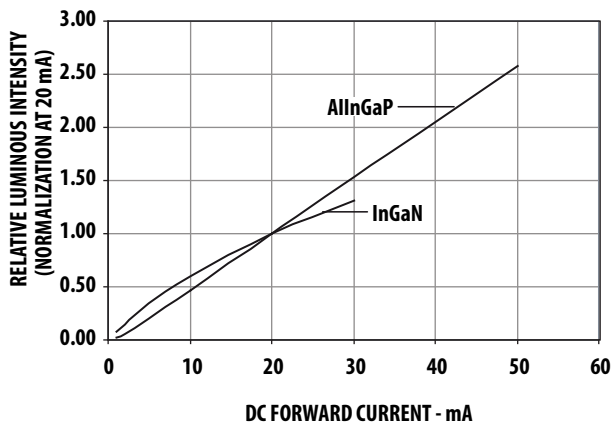
1. Tolerance  $\pm 0.1\text{V}$ .



**Figure 2. Relative intensity vs. wavelength**



**Figure 3. Forward current vs. forward voltage**



**Figure 4. Relative Intensity vs. forward current**

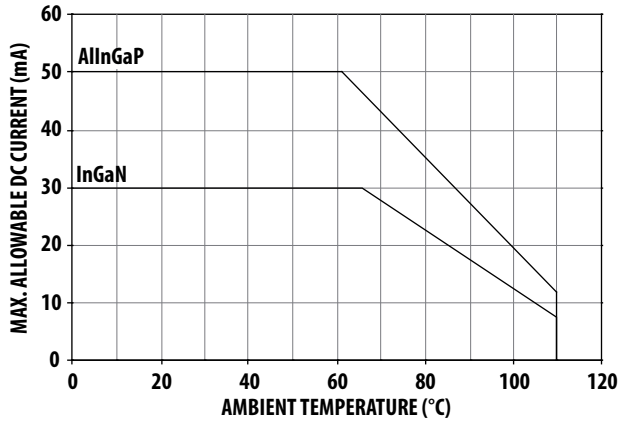


Figure 5a. Maximum forward current vs. ambient temperature. Derated based on  $T_{jMAX} = 125^{\circ}C$ . (3 chips)

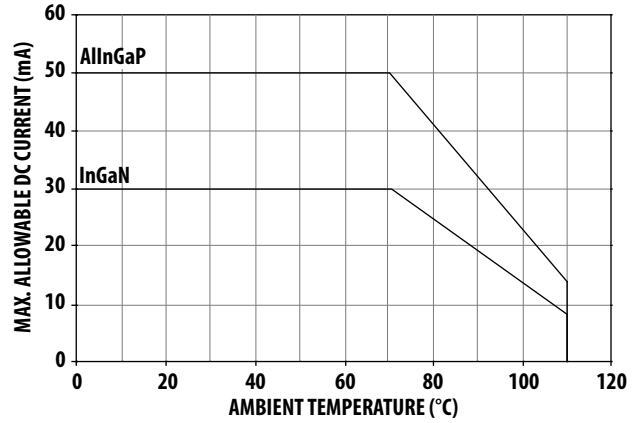


Figure 5b. Maximum forward current vs. ambient temperature. Derated based on  $T_{jMAX} = 125^{\circ}C$ . (single chip)

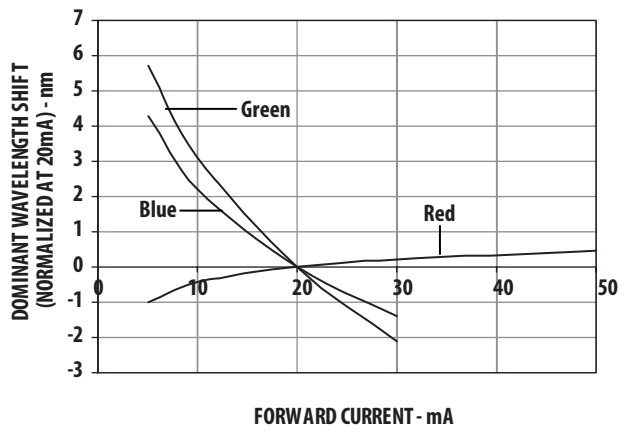


Figure 6. Dominant wavelength shift (normalized at 20mA)

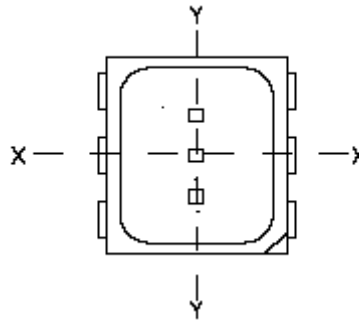


Figure 7a. Component Axis for Radiation Patterns

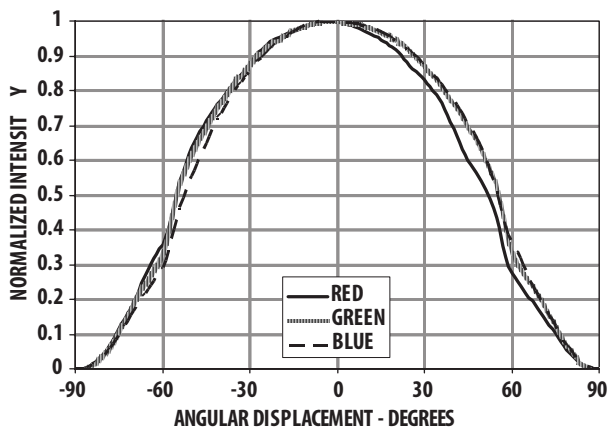


Figure 7b. Radiation Pattern for X axis

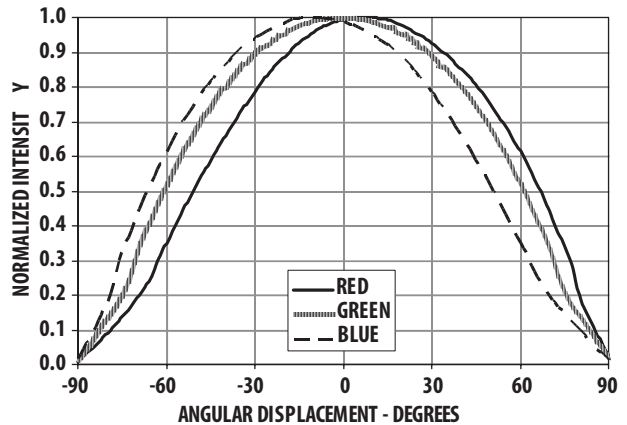


Figure 7c. Radiation Pattern for Y axis

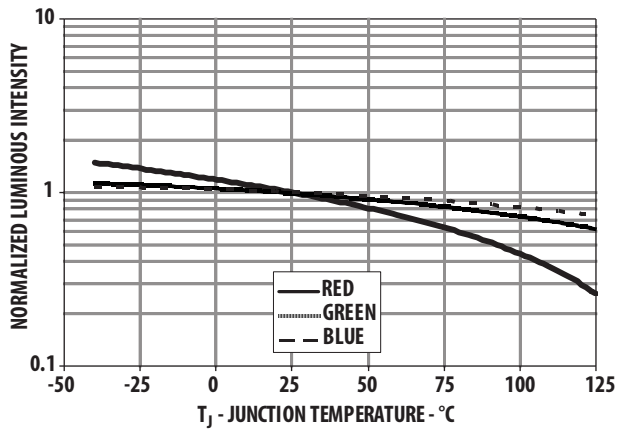


Figure 8. Relative Intensity vs Junction Temperature

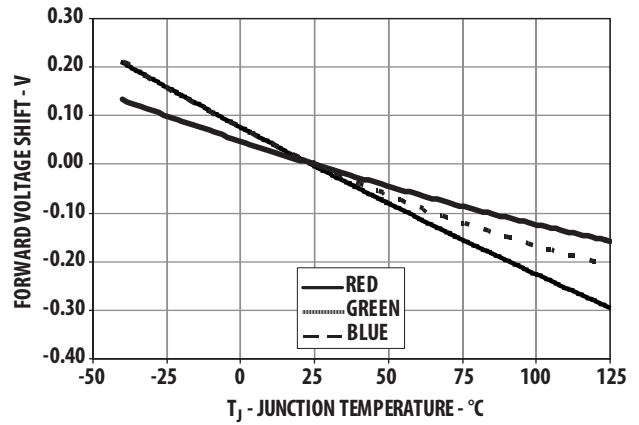


Figure 9. Forward Voltage vs Junction Temperature

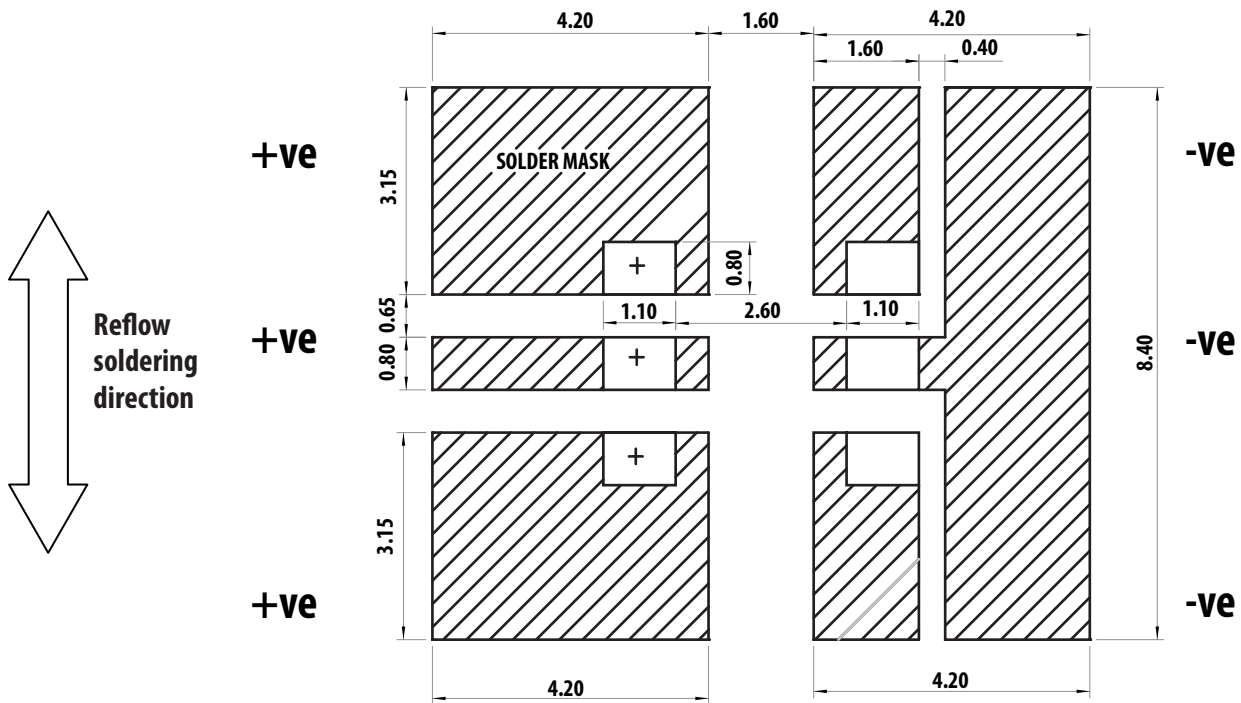
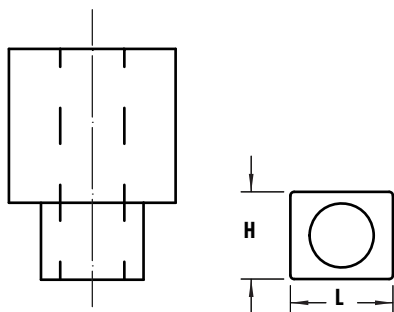


Figure 10. Recommended soldering land pattern.



Dimension of LxH should be > 3.9mm x 3.4mm

Figure 11. Recommended pick and place nozzle tip

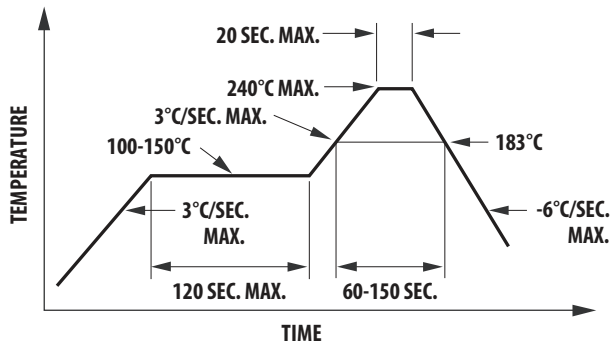


Figure 12. Recommended leaded reflow soldering profile

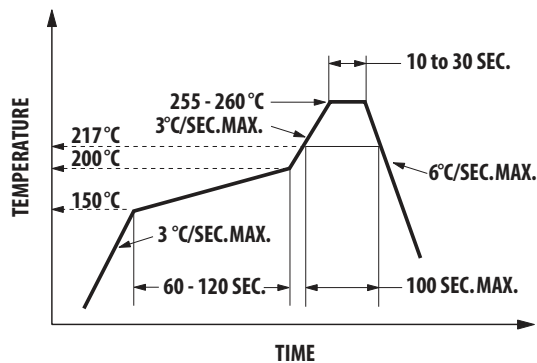


Figure 13. Recommended Pb-free reflow soldering profile.

Note:

For detail information on reflow soldering of Avago surface mount LEDs, do refer to Avago Application Note AN 1060 Surface Mounting SMT LED Indicator Components

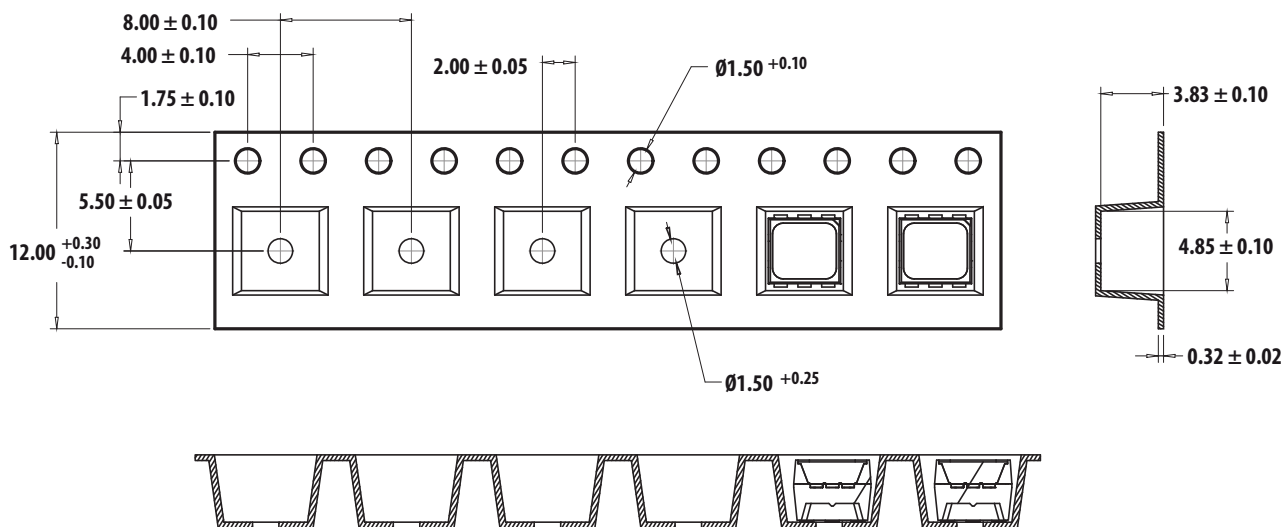


Figure 14. Carrier Tape Dimension

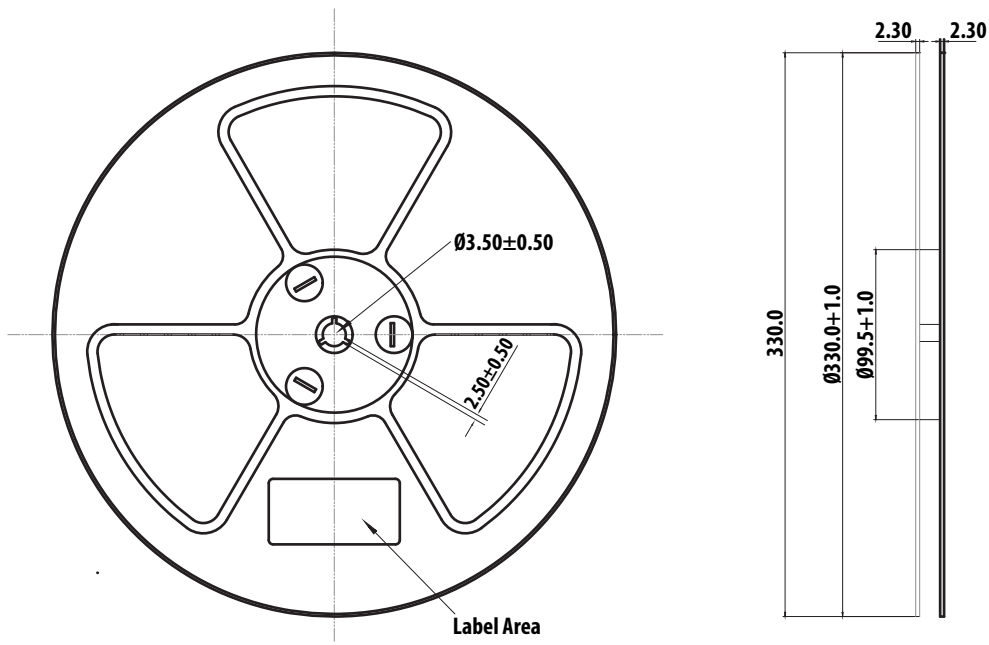


Figure 15. Reel Dimension

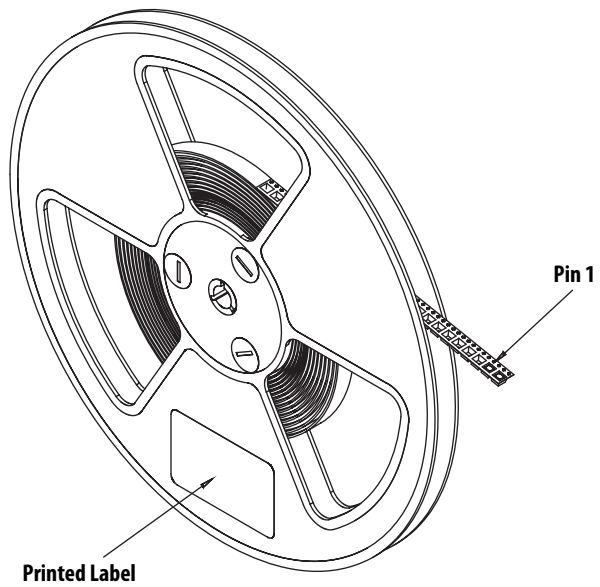


Figure 16. Reeling Orientation



### Intensity Bin Select (X<sub>2</sub>, X<sub>3</sub>)

Individual reel will contain parts from 1 half bin only

X <sub>2</sub>	Min Iv Bin (Minimum Intensity Bin)		
	Red	Green	Blue
0	0	0	0
A	U1	V2	S2

X <sub>3</sub>	Number of Half bin from X <sub>2</sub>		
	Red	Green	Blue
0	0	0	0
A	4	4	4

Note: 0 represents no maximum bin limit

### Color Bin Select (X<sub>4</sub>)

Individual Reel will contain part from 1 full bin only

X <sub>4</sub>	Color Bin Combinations		
	Red	Green	Blue
0	Full distribution	C & D	B & C

### Intensity Bin Limits

Bin ID	Min (mcd)	Max (mcd)
S2	224.0	285.0
T1	285.0	355.0
T2	355.0	450.0
U1	450.0	560.0
U2	560.0	715.0
V1	715.0	900.0
V2	900.0	1125.0
W1	1125.0	1400.0
W2	1400.0	1800.0
X1	1800.0	2240.0

Tolerance of each bin limit ± 12%

### Color Bin Limits

Red	Min (nm)	Max (nm)
Full distribution	618.0	628.0

Green	Min (nm)	Max (nm)
C	525.0	530.0
D	530.0	535.0

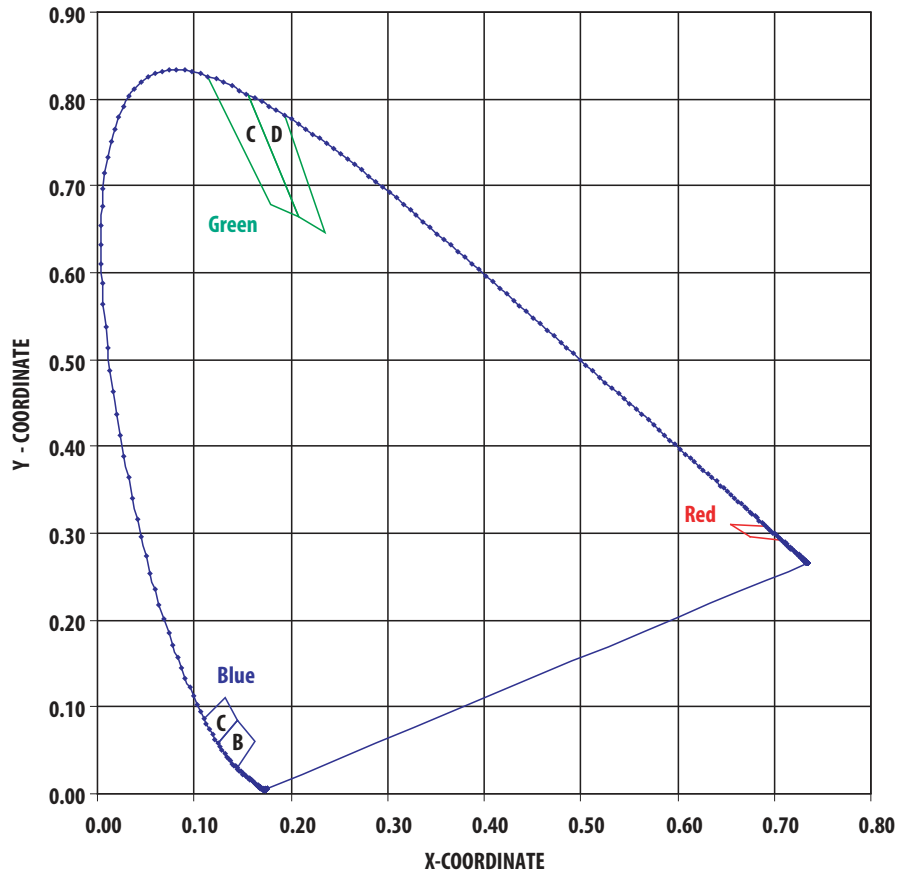
Blue	Min (nm)	Max (nm)
B	465.0	470.0
C	470.0	475.0

Tolerance of each bin limit is ± 1 nm

## Packaging Option (X<sub>5</sub>)

Option	Test Current	Package Type	Reel Size
2	20mA	Top mount	13 inch

Note: Each reel contains 1000pcs LED



## Handling Precaution

The encapsulation material of the product is made of silicone for better reliability of the product. As silicone is a soft material, please do not press on the silicone or poke a sharp object onto the silicone. These might damage the product and cause premature failure. During assembly or handling, the unit should be held on the body only. Please refer to Avago Application Note AN 5288 for detail information.

## Moisture Sensitivity

This product is qualified as Moisture Sensitive Level 2a per J-STD-020. Precautions when handling this moisture sensitive product is important to ensure the reliability of the product. Do refer to Avago Application Note AN5305 Handling of Moisture Sensitive Surface Mount Devices for details.

### A. Storage before use

- Unopen moisture barrier bag (MBB) can be stored at <math><40^{\circ}\text{C}</math>/90%RH for 12 months. If the actual shelf life has exceeded 12 months and the HIC indicates that baking is not required, then it is safe to reflow the LEDs per the original MSL rating.
- It is not recommended to open the MBB prior to assembly (e.g. for IQC).

### B. Control after opening the MBB

- The humidity indicator card (HIC) shall be read immediately upon opening of MBB.
- The LEDs must be kept at <math><30^{\circ}\text{C}</math> / 60%RH at all time and all high temperature related process including soldering, curing or rework need to be completed within 672 hours.

### C. Control for unfinished reel

- For any unused LEDs, they need to be stored in sealed MBB with desiccant or desiccator at <math><5\%</math>RH.

### D. Control of assembled boards

- If the PCB soldered with the LEDs is to be subjected to other high temperature processes, the PCB need to be stored in sealed MBB with desiccant or desiccator at <math><5\%</math>RH to ensure no LEDs have exceeded their floor life of 672 hours

### E. Baking is required if:

- The HIC indicator is not GREEN at 10% and is AZURE at 5%
- The LEDs are exposed to condition of <math>>30^{\circ}\text{C}</math> / 60% RH at any time.
- The LED floor life exceeded 672hrs.

Recommended baking condition:  $60\pm 5^{\circ}\text{C}$  for 20hrs.

For product information and a complete list of distributors, please go to our web site: [www.avagotech.com](http://www.avagotech.com)